SD Ceramic Printer KS301C

> Multiple materials

The printer is capable of printing a variety of materials: Al2O3, SiO2, Si3Zr, HAP, etc.

> Temperature-controlled

It can control the strength at both high and low temperatures to 20MPa (Sizr).

> 100% theoretical density

It has an expansion of 0.9% at 1500°C (Sizr) and a deflection of 0.1mm at 1500°C (Sizr).

Expansion and deflection

When combined with special ceramic slurry and raw materials, the sintered products approach 100% theoretical density.

> High-precision printing

It has high printing precision, accurately representing details of 200 µm and above.

> High product strength

The strength of the products after sintering reaches or even exceeds that of traditional ceramic forming processes (such as pressing and injection molding).



TECHNICAL DATA	KS301C
Dimensions (L \times W \times H)	1980×1340×2150mm
Molding Range (L \times W \times H)	300×300×160mm
Printing Speed	6000-10000mm/s
Printing Thickness	0.05mm
Printing Accuracy	±0.1mm
Surface Finish	Ra1um~2μm
Power Supply Requirements	220-240 VAC/50Hz
Total Machine Power	5.5kW





TECHNICAL DATA	KS301C
Light Source Type	UV Laser
Laser Wavelength	355nm
Focus Diameter	30μm
Room Temperature Requirements	20-25℃
Humidity Requirements	Below 50%
Compressed Air	6 bars
	SiO2, Al2O3, ZrO2, HAP/TCP,
Printing Materials	silicon-zirconium
	composite materials, etc.



https://www.kangshuoim.com/

